

# KW CELMM1.TG

## OSLON® Boost HM

OSLON Boost HM utilizes the high current capability of the latest chip generation in a special package for good thermal behaviour. The LED is characterized by a high luminance of up to 255 cd / mm<sup>2</sup> and a high luminous flux. Therefore this LED is ideally suited as a powerful light source for ultra-slim headlamp designs.



## Applications

- Headlamps, LED & Laser & Night Vision

## Features:

- Package: Ceramic package
- Chip technology: UX:3
- Typ. Radiation: 120° (Lambertian emitter)
- Color: Cx = 0.325, Cy = 0.345 acc. to CIE 1931 (• white)
- Corrosion Robustness Class: 3A
- Qualifications: AEC-Q102 Qualified
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)
- Color over angle: Better than passus 3.7.2.1 of supplement proposal 7 to ECE reg. 128

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## Ordering Information

Type	Luminous Flux <sup>1)</sup> $I_F = 1500 \text{ mA}$ $\Phi_V$	Ordering Code
KW CELMM1.TG-S3SB-4L07M0-8F8H	375 ... 585 lm	Q65113A0743

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## Maximum Ratings

Parameter	Symbol		Values
Operating Temperature <sup>2)</sup>	$T_{op}$	min.	-40 °C
		max.	135 °C
Storage Temperature	$T_{stg}$	min.	-40 °C
		max.	135 °C
Junction Temperature	$T_j$	max.	150 °C
Junction Temperature for short time applications*	$T_j$	max.	175 °C
Forward current $T_s = 25\text{ °C}$	$I_F$	min.	50 mA
		max.	1650 mA
Forward current pulsed $D = 0.005 ; T_s = 25\text{ °C}$	$I_{F\ pulse}$	max.	2000 mA
Surge current $t \leq 10\ \mu s ; D = 0.005 ; T_s = 25\text{ °C}$	$I_{FS}$	max.	2500 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	$V_{ESD}$		8 kV
Reverse current <sup>3)</sup>	$I_R$	max.	200 mA

\* The median lifetime (L70/B50) for  $T_j = 175\text{ °C}$  is 100h.

## Characteristics

$I_F = 1500 \text{ mA}$ ;  $T_S = 25 \text{ °C}$

Parameter	Symbol		Values
Chromaticity Coordinate <sup>4)</sup>	$C_x$	typ.	0.325
	$C_y$	typ.	0.345
Viewing angle at 50% $I_V$	$2\phi$	typ.	120 °
Forward Voltage <sup>5)</sup> $I_F = 1500 \text{ mA}$	$V_F$	min.	3.00 V
		typ.	3.41 V
		max.	3.75 V
Reverse voltage (ESD device)	$V_{R\text{ESD}}$	min.	45 V
Reverse voltage <sup>3)</sup> $I_R = 20 \text{ mA}$	$V_R$	max.	1.2 V
Real thermal resistance junction/solderpoint <sup>6)</sup>	$R_{\text{thJS real}}$	typ.	6.7 K / W
		max.	8.1 K / W
Electrical thermal resistance junction/solderpoint <sup>6)</sup> with efficiency $\eta_e = 26 \%$	$R_{\text{thJS elec.}}$	typ.	5.0 K / W
		max.	6.0 K / W

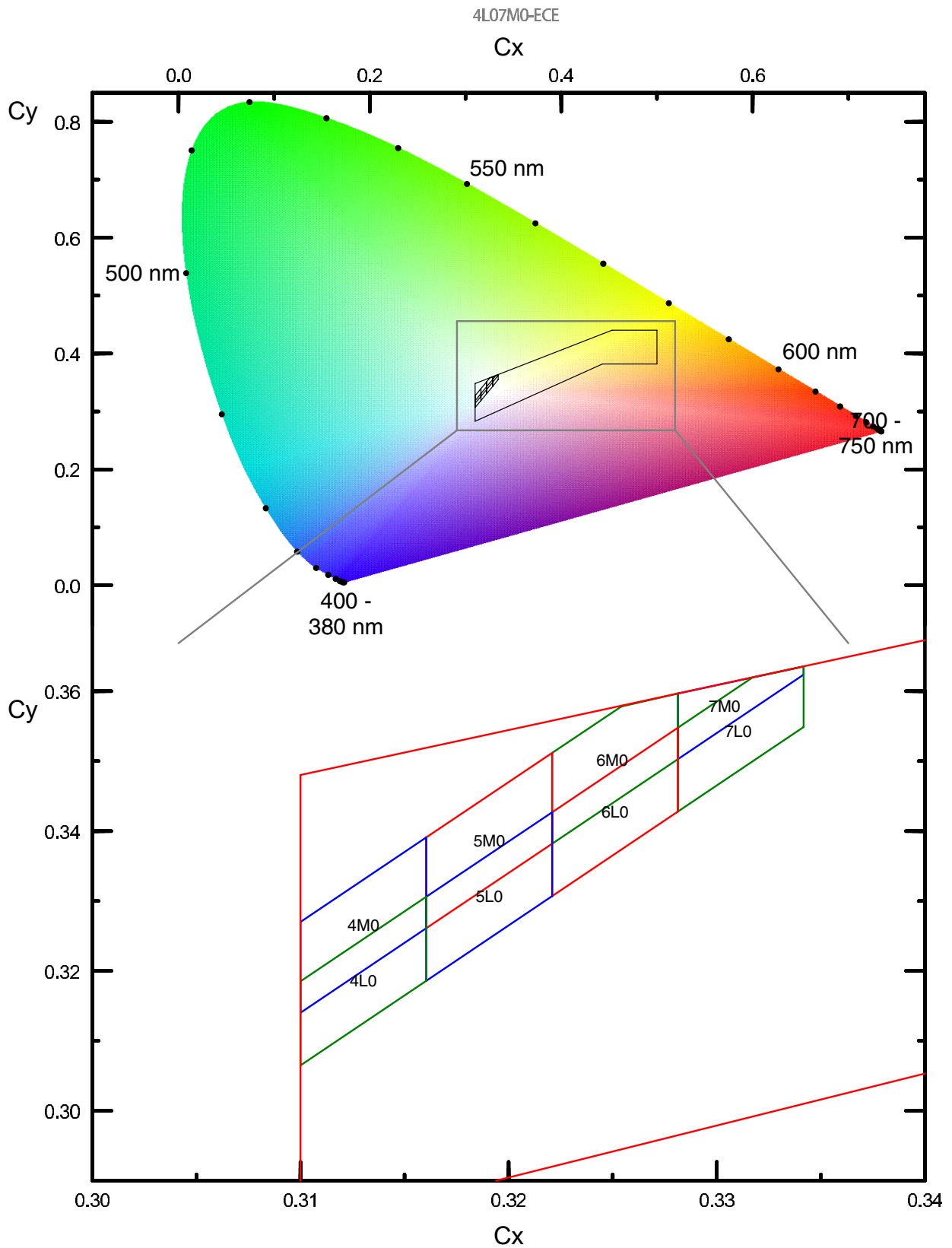
## Brightness Groups

Group	Luminous Flux <sup>1)</sup> $I_F = 1500 \text{ mA}$ min. $\Phi_V$	Luminous Flux <sup>1)</sup> $I_F = 1500 \text{ mA}$ max. $\Phi_V$
S3	375 lm	395 lm
S4	395 lm	415 lm
S5	415 lm	435 lm
S6	435 lm	460 lm
S7	460 lm	485 lm
S8	485 lm	510 lm
S9	510 lm	535 lm
SA	535 lm	560 lm
SB	560 lm	585 lm

## Forward Voltage Groups

Group	Forward Voltage <sup>5)</sup> $I_F = 1500 \text{ mA}$ min. $V_F$	Forward Voltage <sup>5)</sup> $I_F = 1500 \text{ mA}$ max. $V_F$
8F	3.00 V	3.25 V
8G	3.25 V	3.50 V
8H	3.50 V	3.75 V

## Chromaticity Coordinate Groups



## Chromaticity Coordinate Groups <sup>4)</sup>

Group	Cx	Cy	Group	Cx	Cy	Group	Cx	Cy
4L0	0.3100	0.3065	5M0	0.3160	0.3261	7L0	0.3281	0.3428
	0.3100	0.3185		0.3160	0.3391		0.3281	0.3548
	0.3160	0.3306		0.3221	0.3512		0.3317	0.3620
	0.3160	0.3186		0.3221	0.3382		0.3342	0.3635
4M0	0.3100	0.3140	6L0	0.3221	0.3307	7M0	0.3281	0.3503
	0.3100	0.3270		0.3221	0.3427		0.3281	0.3597
	0.3160	0.3391		0.3281	0.3548		0.3342	0.3635
	0.3160	0.3261		0.3281	0.3428		0.3342	0.3624
5L0	0.3160	0.3186	6M0	0.3221	0.3382			
	0.3160	0.3306		0.3221	0.3512			
	0.3221	0.3427		0.3254	0.3578			
	0.3221	0.3307		0.3281	0.3597			
				0.3281	0.3503			

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## Group Name on Label

**Example: S3-4L0-8F**

Brightness

Color Chromaticity

Forward Voltage

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S3

4L0

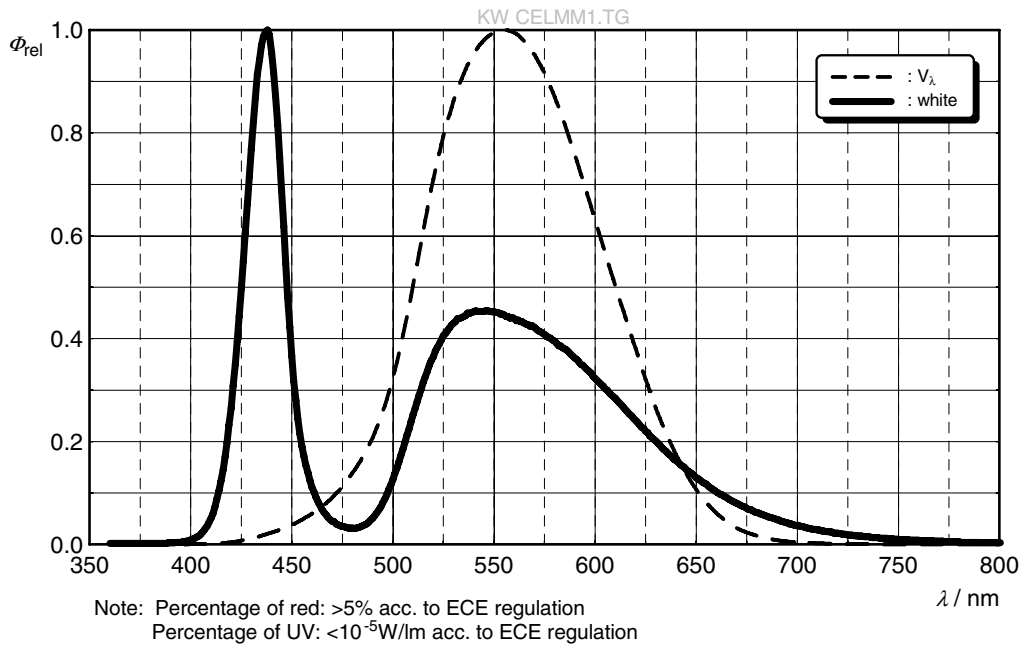
8F

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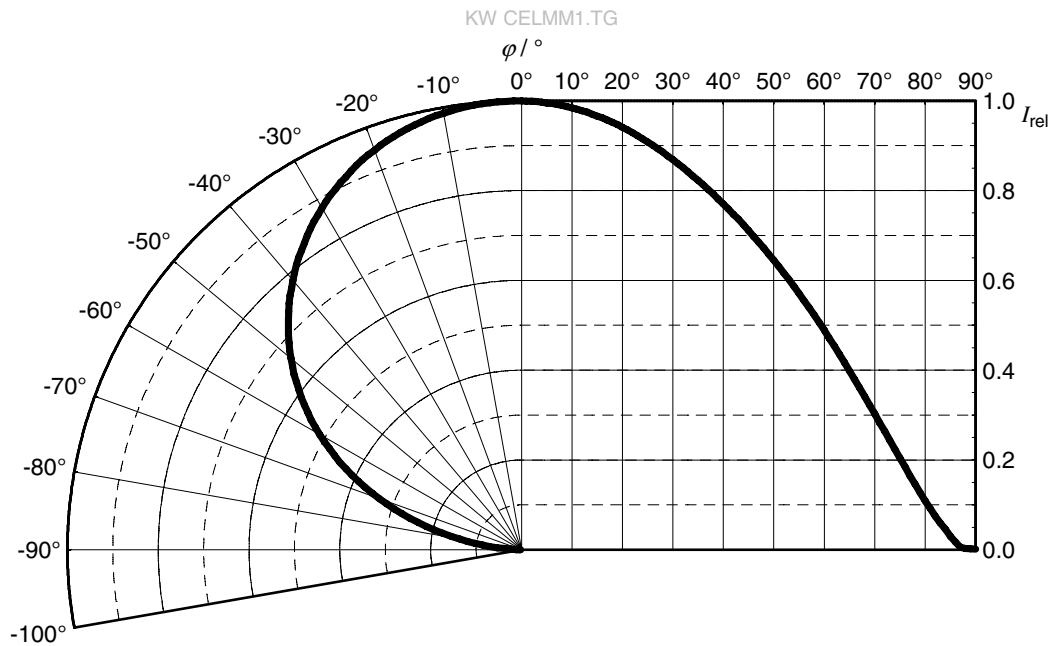
### Relative Spectral Emission <sup>7)</sup>

$\Phi_{rel} = f(\lambda); I_F = 1500 \text{ mA}; T_J = 25 \text{ }^\circ\text{C}$



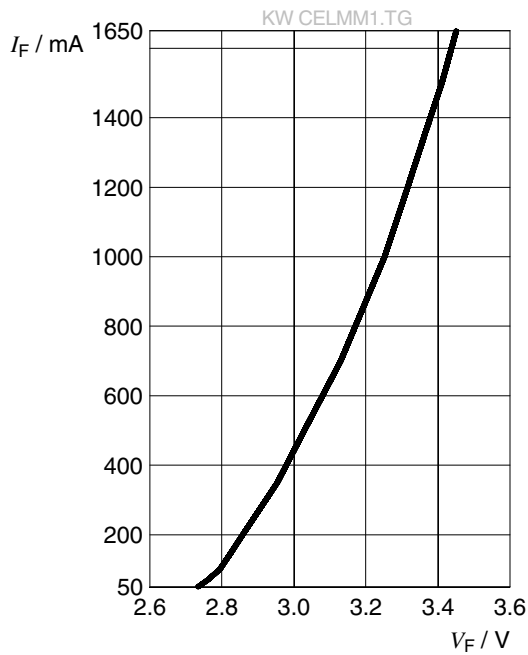
### Radiation Characteristics <sup>7)</sup>

$I_{rel} = f(\phi); T_J = 25 \text{ }^\circ\text{C}$



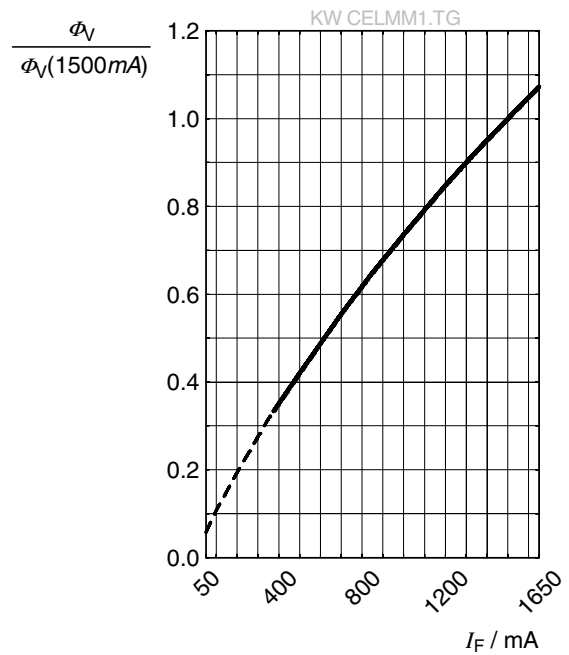
**Forward current** <sup>7)</sup>

$I_F = f(V_F); T_J = 25\text{ °C}$



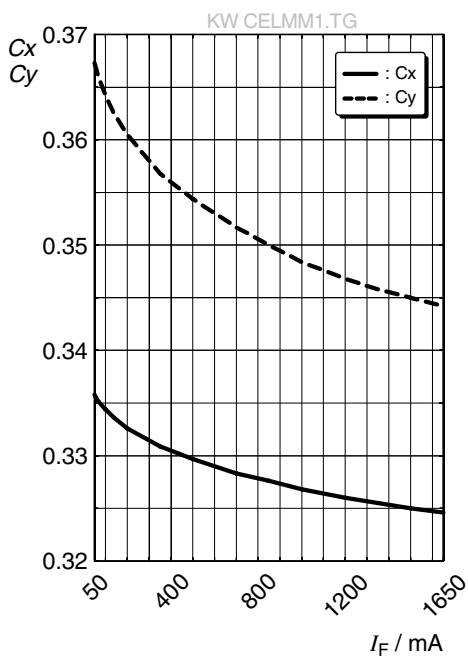
**Relative Luminous Flux** <sup>7), 8)</sup>

$\Phi_V / \Phi_V(1500\text{ mA}) = f(I_F); T_J = 25\text{ °C}$



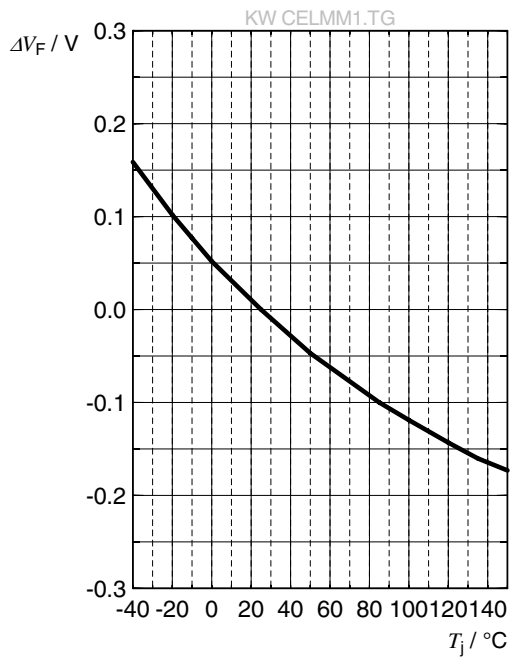
**Chromaticity Coordinate Shift** <sup>7)</sup>

$C_x, C_y = f(I_F); T_J = 25\text{ °C}$



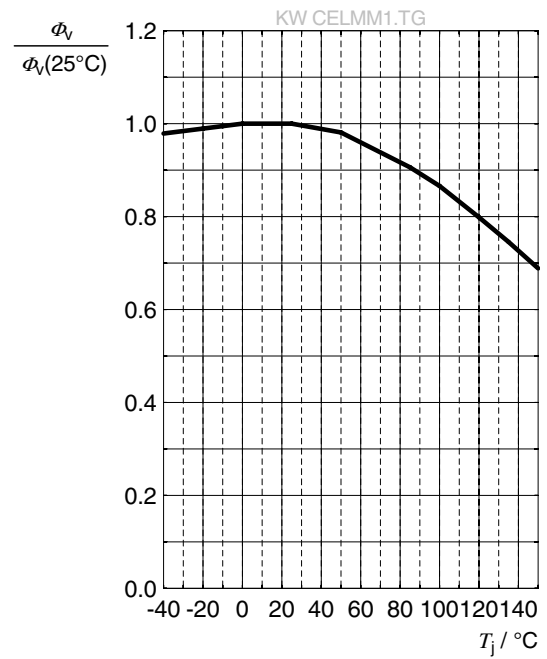
### Forward Voltage <sup>7)</sup>

$$\Delta V_F = V_F - V_F(25\text{ °C}) = f(T_j); I_F = 1500\text{ mA}$$



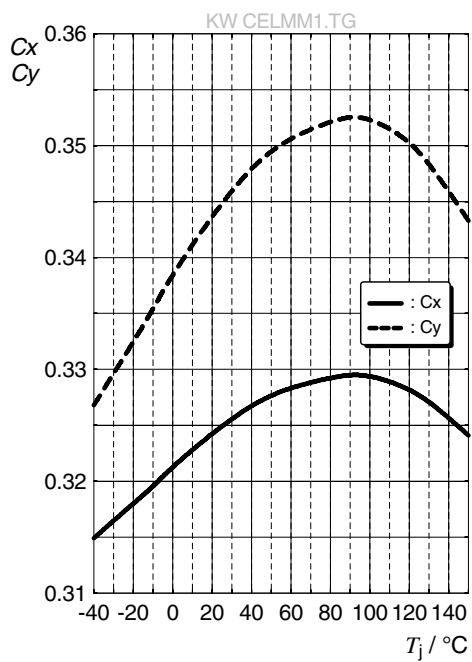
### Relative Luminous Flux <sup>7)</sup>

$$\Phi_V / \Phi_V(25\text{ °C}) = f(T_j); I_F = 1500\text{ mA}$$



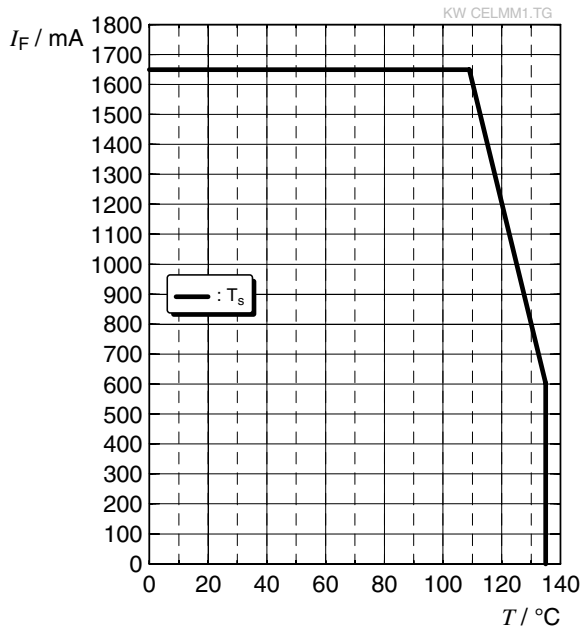
### Chromaticity Coordinate Shift <sup>7)</sup>

$$C_x, C_y = f(T_j); I_F = 1500\text{ mA}$$



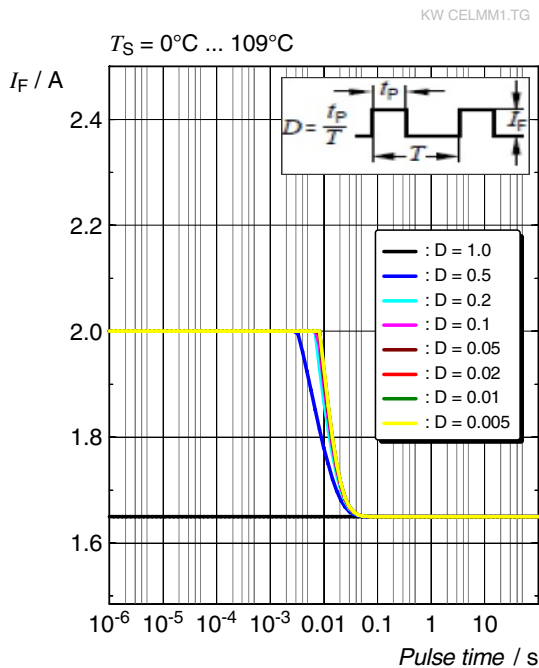
## Max. Permissible Forward Current

$$I_F = f(T)$$



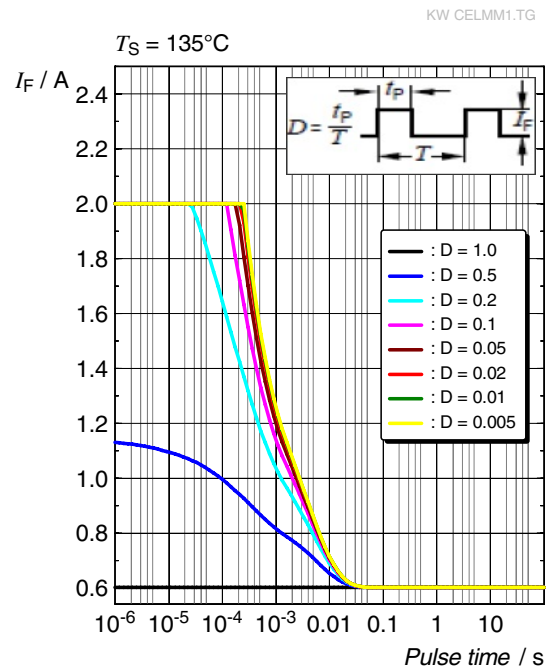
## Permissible Pulse Handling Capability

$$I_F = f(t_p); D: \text{Duty cycle}$$



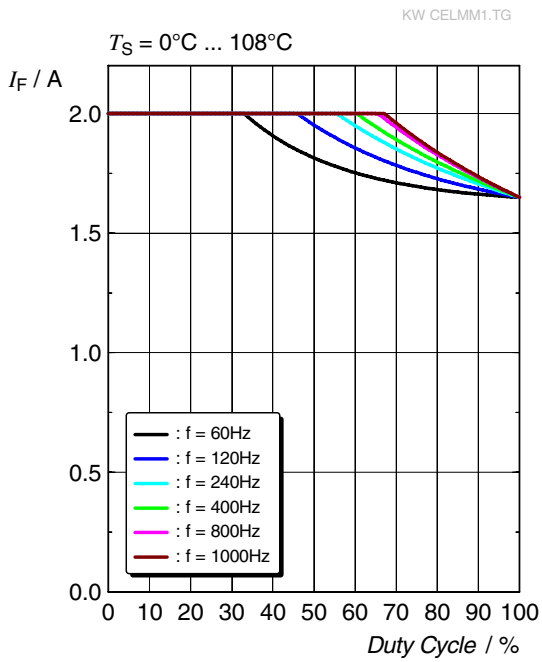
## Permissible Pulse Handling Capability

$$I_F = f(t_p); D: \text{Duty cycle}$$



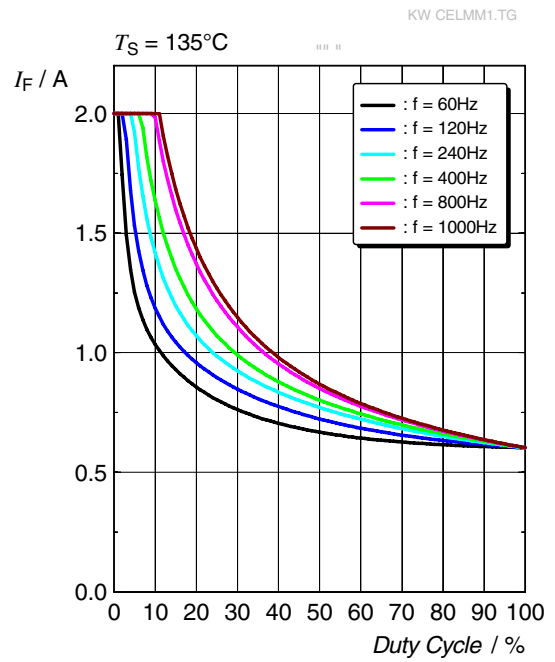
### Permissible F. Handling Capability

f: Frequency

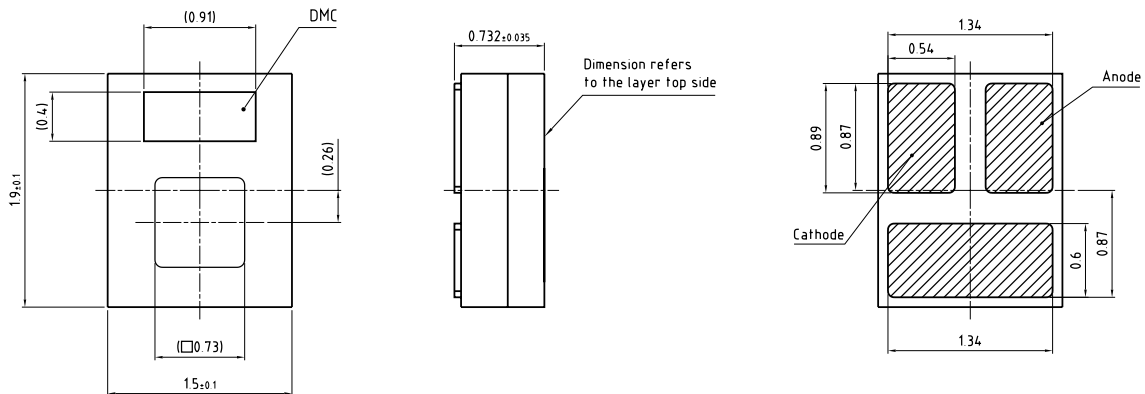


### Permissible F. Handling Capability

f: Frequency



## Dimensional Drawing <sup>9)</sup>



general tolerance  $\pm 0.05$

lead finish Au 

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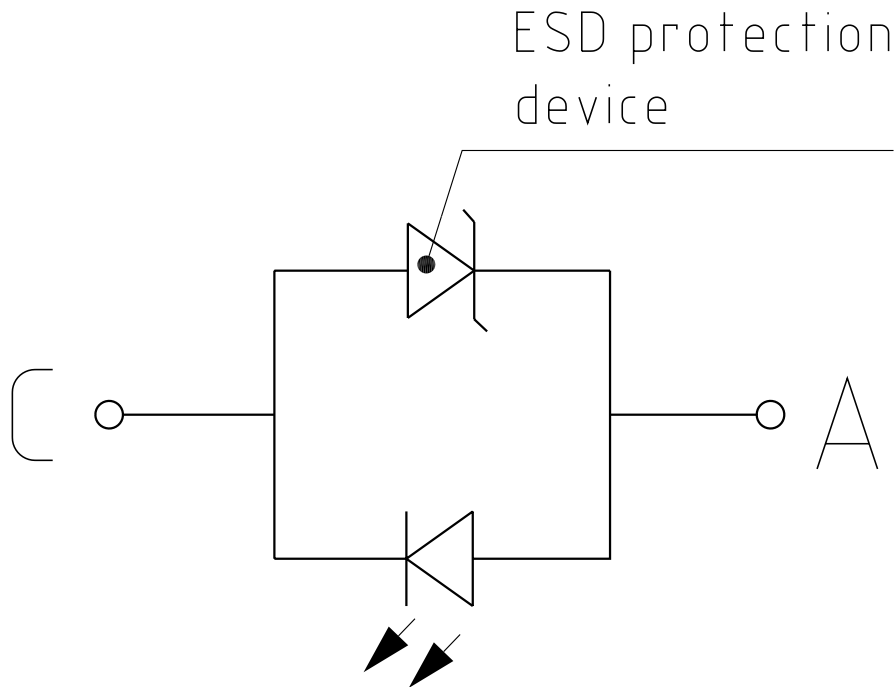
## Further Information:

**Approximate Weight:** 7.8 mg

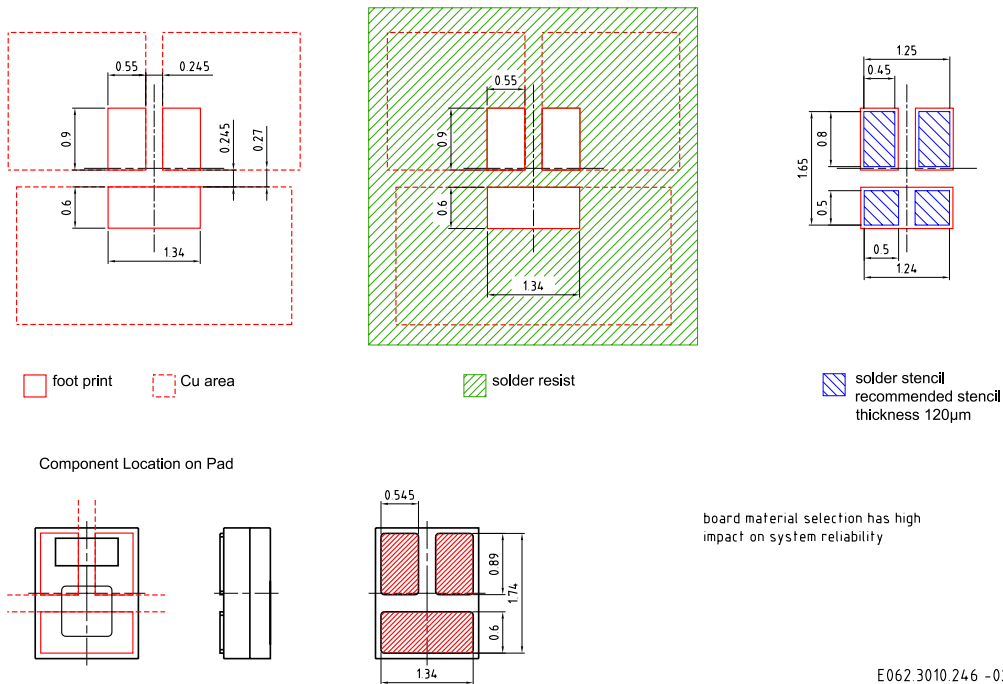
**Corrosion test:** Class: 3A  
 Test condition:  $40^{\circ}\text{C}$  / 90 % RH / 15 ppm  $\text{H}_2\text{S}$  / 14 days (stricter than IEC 60068-2-43)

**ESD advice:** The device is protected by ESD device which is connected in parallel to the Chip.

## Electrical Internal Circuit



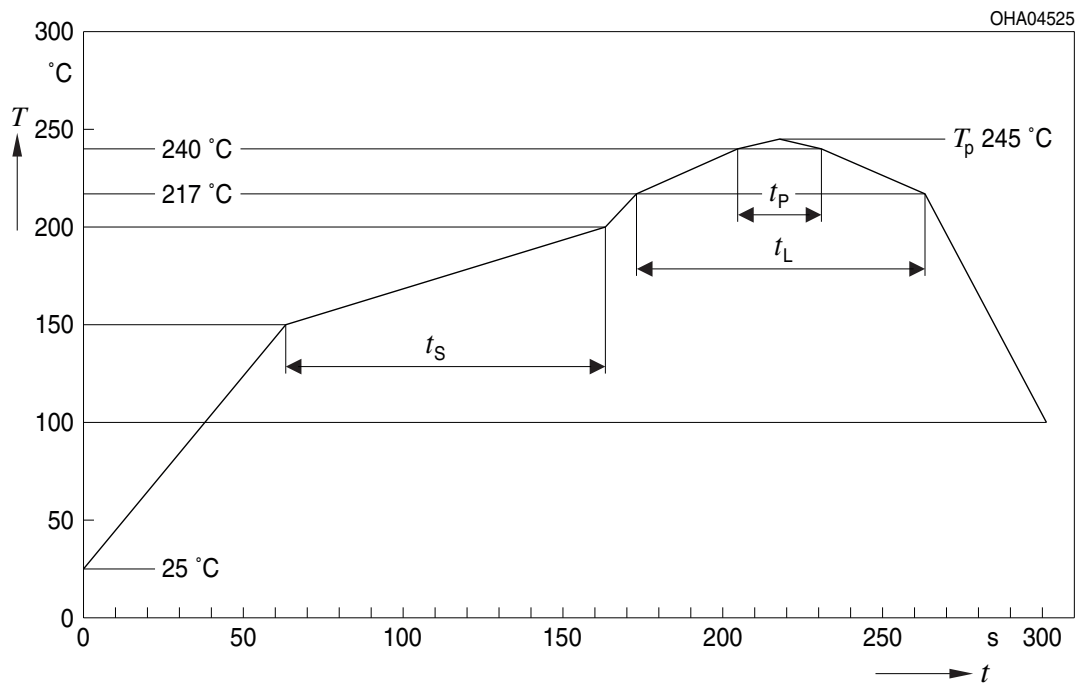
## Recommended Solder Pad <sup>9)</sup>



For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning. To ensure a high solder joint reliability and to minimize the risk of solder joint cracks, the customer is responsible to evaluate the combination of PCB board and solder paste material for his application.

## Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



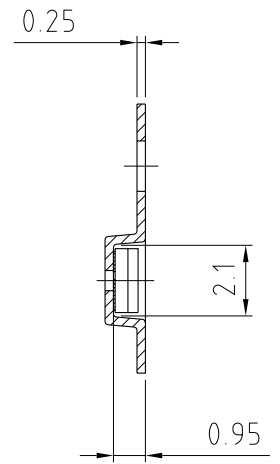
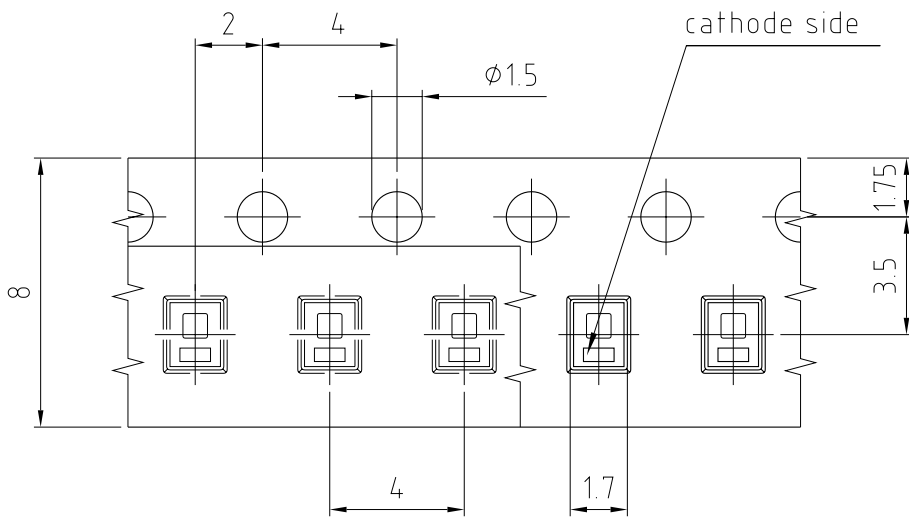
Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat <sup>*)</sup> 25 °C to 150 °C			2	3	K/s
Time $t_s$ $T_{Smin}$ to $T_{Smax}$	$t_s$	60	100	120	s
Ramp-up rate to peak <sup>*)</sup> $T_{Smax}$ to $T_p$			2	3	K/s
Liquidus temperature	$T_L$		217		°C
Time above liquidus temperature	$t_L$		80	100	s
Peak temperature	$T_p$		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5$ K	$t_p$	10	20	30	s
Ramp-down rate* $T_p$ to 100 °C			3	6	K/s
Time 25 °C to $T_p$				480	s

All temperatures refer to the center of the package, measured on the top of the component

\* slope calculation  $DT/Dt$ :  $Dt$  max. 5 s; fulfillment for the whole T-range

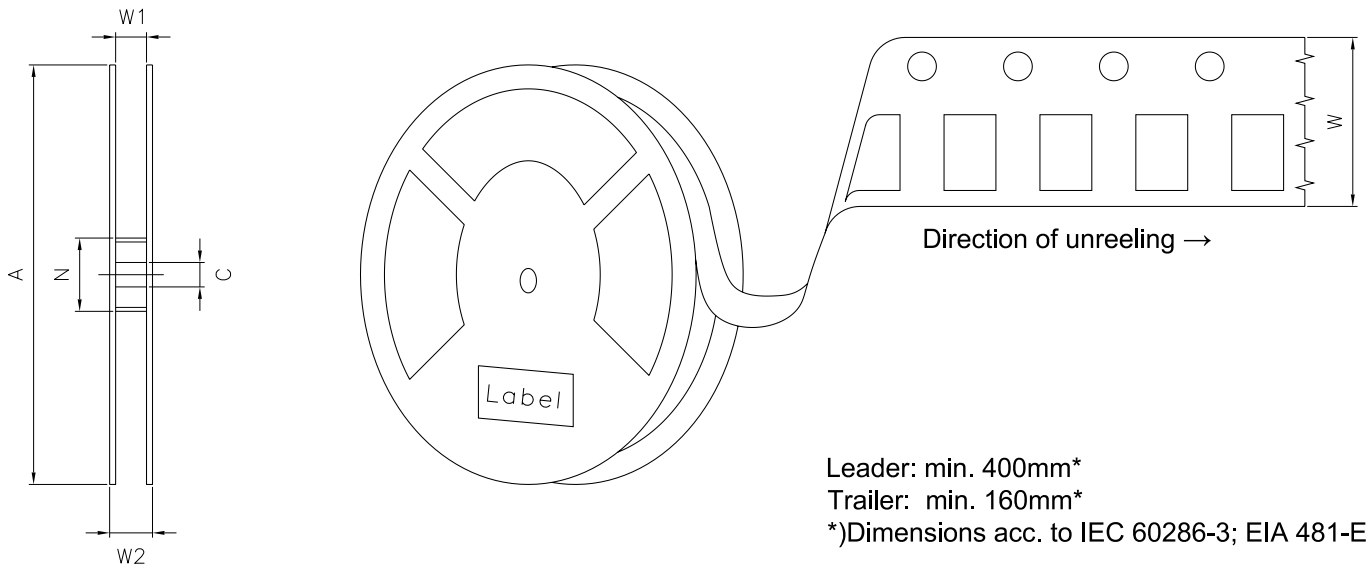


**Taping** <sup>9)</sup>



C63062-A4372-B7-02

**Tape and Reel** <sup>10)</sup>



**Reel Dimensions**

A	W	$N_{min}$	$W_1$	$W_{2max}$	Pieces per PU
180 mm	$8 + 0.3 / - 0.1$ mm	60 mm	$8.4 + 2$ mm	14.4 mm	4000

### Barcode-Product-Label (BPL)

**OSRAM Opto Semiconductors** LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

(6P) BATCH NO: 1234567890

(1T) LOT NO: 1234567890 (9D) D/C: 1234

(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X

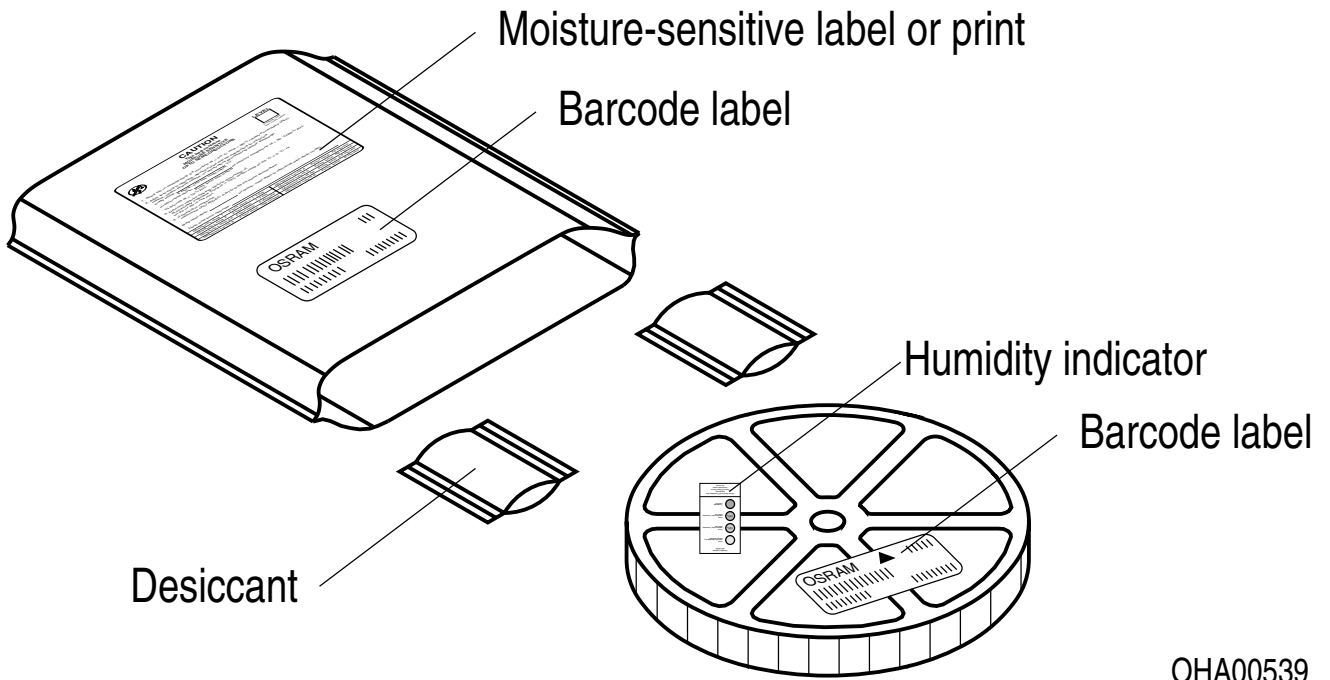
ML Temp ST  
X XXX °C X

Pack: RXX  
DEMY XXX  
X\_X123\_1234.1234 X

The diagram shows a rectangular label with rounded corners. It contains the OSRAM logo and product name at the top left. To the right are fields for 'LX XXXX' and 'BIN1: XX-XX-X-XXX-X'. Below this is 'RoHS Compliant'. The main body of the label features three rows of information, each with a barcode: '(6P) BATCH NO: 1234567890', '(1T) LOT NO: 1234567890 (9D) D/C: 1234', and '(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X'. To the right of the second row is a 'No moisture' symbol (a circle with a diagonal line and three drops) and 'ML Temp ST X XXX °C X'. Below that is 'Pack: RXX', 'DEMY XXX', and 'X\_X123\_1234.1234 X'. A square QR code is located on the right side of the label.

OHA04563

### Dry Packing Process and Materials <sup>9)</sup>



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

## Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers avoid device exposure to aggressive substances during storage, production, and use.

For further application related information please visit [www.osram-os.com/appnotes](http://www.osram-os.com/appnotes)

## Disclaimer

### **Attention please!**

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

### **Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

### **Product and functional safety devices/applications or medical devices/applications**

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

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## Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 1 ms, with an internal reproducibility of  $\pm 8\%$  and an expanded uncertainty of  $\pm 11\%$  (acc. to GUM with a coverage factor of  $k = 3$ ).
- 2) **Operating Temperature:** The Operating Temperature  $T_{op}$  is referenced to the Solderpoint  $T_s$  of this device. Proper current derating must be observed to maintain junction temperature below the maximum.
- 3) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 4) **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a current pulse of typically 1 ms, with an internal reproducibility of  $\pm 0.005$  and an expanded uncertainty of  $\pm 0.01$  (acc. to GUM with a coverage factor of  $k = 3$ ).
- 5) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 1 ms, with an internal reproducibility of  $\pm 0.05\text{ V}$  and an expanded uncertainty of  $\pm 0.1\text{ V}$  (acc. to GUM with a coverage factor of  $k = 3$ ).
- 6) **Thermal Resistance:**  $R_{th\ max}$  is based on statistic values ( $6\sigma$ ).
- 7) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 8) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with  $\pm 0.1$  and dimensions are specified in mm.
- 10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

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## Revision History

Version	Date	Change
1.0	2019-12-05	Initial Version
1.1	2021-03-15	Product Image Features Ordering Information Characteristics Brightness Groups Chromaticity Coordinate Groups Group Name on Label Electro - Optical Characteristics (Diagrams) Derating (Diagrams) Dimensional Drawing Recommended Solder Pad Reel Dimensions Glossary
1.2	2021-07-26	Features

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